



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
 Address: COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450  
 www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 3722

SERIAL NUMBER 10/700,136	FILING DATE 11/03/2003  RULE	CLASS 257	GROUP ART UNIT 2811	ATTORNEY DOCKET NO. 03663/LH
-----------------------------	---------------------------------------	--------------	------------------------	------------------------------------

## APPLICANTS

Tomio Matsuzaki, Tokyo, JAPAN;

Kazuyoshi Arai, Tokyo, JAPAN;

## \*\* CONTINUING DATA \*\*\*\*\*

*none*  
*Loke*

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

JAPAN 2002-324973 11/08/2002

JAPAN 2003-147447 05/26/2003

JAPAN 2003-324204 09/17/2003

*Loke*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 02/06/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR  COUNTRY JAPAN	SHEETS  DRAWING 56	TOTAL  CLAIMS 35	INDEPENDENT  CLAIMS 2
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature <i>Shawn Loke</i>	Initials <i>SL</i>		

## ADDRESS

01933

FRISHAUF, HOLTZ, GOODMAN &amp; CHICK, PC

767 THIRD AVENUE

25TH FLOOR

NEW YORK, NY

10017-2023

## TITLE

Wiring structure on semiconductor substrate and method of fabricating the same

FILING FEE	FEES: Authority has been given in Paper	<input type="checkbox"/> All Fees
		<input type="checkbox"/> 1.16 Fees ( Filing )
		<input type="checkbox"/> 1.17 Fees ( Processing Ext. of

RECEIVED 1040	No. _____ to charge/credit DEPOSIT ACCOUNT	(time )
	No. _____ for following:	<input type="checkbox"/> 1.18 Fees ( Issue )
		<input type="checkbox"/> Other _____
		<input type="checkbox"/> Credit _____